IPC ASSOCIATION CONNE	Material Comp © Copyright 2005. Il international and Par	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					terials and	ials and Mfg Information			
upplier Info	rmation								·						
Company name*			Company unique ID			Un	Unique ID Authority				Respo	Response Date*			
onsemi											2023-0	2023-06-08			
Contact Name			Title - Contact			Ph	Phone - Contact*				Email	Email - Contact*			
Product-Env-Ste	ewards		Product Enviro Compliance			N.	NA				Produ	Product-Env-Stewards@onsemi.com			
uthorized Repr	resentative*		Title - Representative			Ph	Phone - Representative*				Email	Email - Representative*			
Product-Env-Ste	ewards		Product Enviro Compliance			N.	NA				Produ	Product-Env-Stewards@onsemi.com			
Reque	Requester Item Number Mfr I		Item Number Mfr Item Name			Е	Effective Date Version		ı	Manufacturing Site		Weight*	UOM	Unit Type	
		NCP81149MNTXG Single-Phase Vo Interface - Indust		Single-Phase Volta Interface - Industri	age Regulator with SV ial Temp Range	VID 2	2023-06-08 PH1			118.03	mg	Each			
Ianufacturi r	ng Proccess Informa	tion													
Terminal Plating / Grid Array Material T			Cerminal Base Alloy J-STD-020 MSI		-STD-020 MSL Ratin	ıg	Peak Process Body Temperature Max Time a		re Max Time at Po	eak Temper	rature Num	ber of Reflow Cyo	eles		
Matte Tin (Sn) - annealed		CU Alloy 3		}		260 C		C	30 seco		onds 3				
omments															
TTENTION: M	ASL 3 Rated item require	s Bake and D	Ory Pack (afte	r electrical test)											
or more inform	ation regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Isability and the Company's remedies for issues that arise regarding information the Supplier pro											
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	astislav Drska	-En									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.48	mg	Supplier	Silicon (Si)	7440-21-3		3.48	mg
Die Attach Solder	3.37	mg	Supplier	Silver (Ag)	7440-22-4		0.0842	mg
			A	Lead (Pb)	7439-92-1	7a	3.1172	mg
			Supplier	Tin (Sn)	7440-31-5		0.1685	mg
Lead Frame	57.28		Supplier	Silver (Ag)	7440-22-4		0.2291	mg
			Supplier	Tin (Sn)	7440-31-5		0.1432	mg
			Supplier	Zinc (Zn)	7440-66-6		0.126	mg
			Supplier	Chromium (Cr)	7440-47-3		0.1432	mg
			Supplier	Copper (Cu)	7440-50-8		56.6385	mg
Mold Compound-Black	49.82	mg		Epoxy Phenol Resin	proprietary data		5.2311	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		44.5889	mg
Plating	2.76	mg	Supplier	Tin (Sn)	7440-31-5		2.76	mg
Wire Bond - Au	1.32	mg	Supplier	Gold (Au)	7440-57-5		1.32	mg